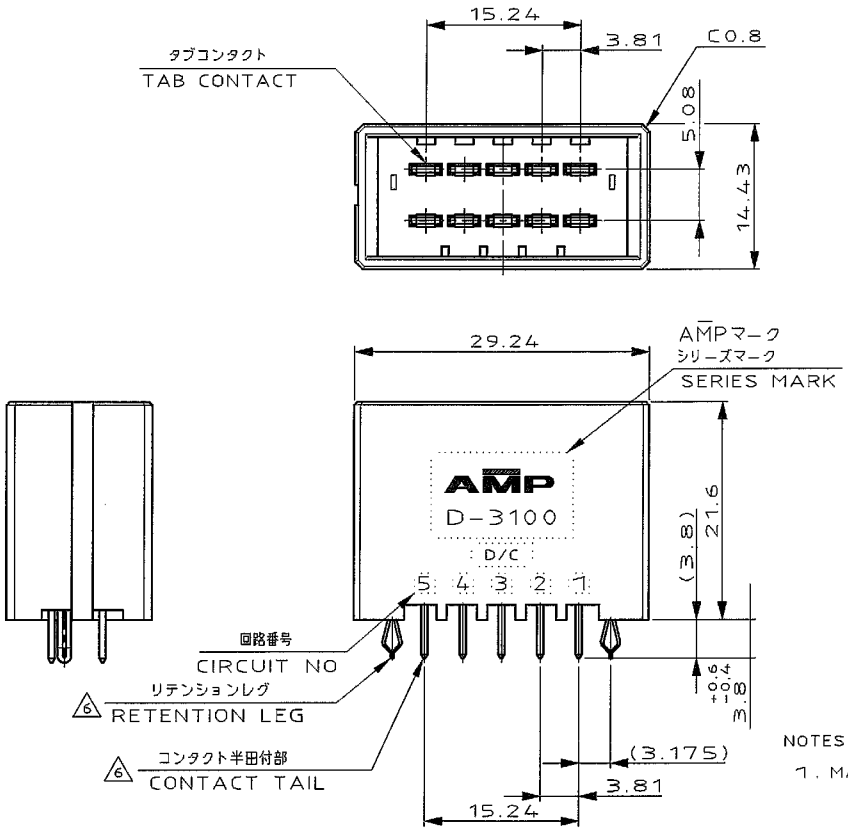
NUMBER 178325

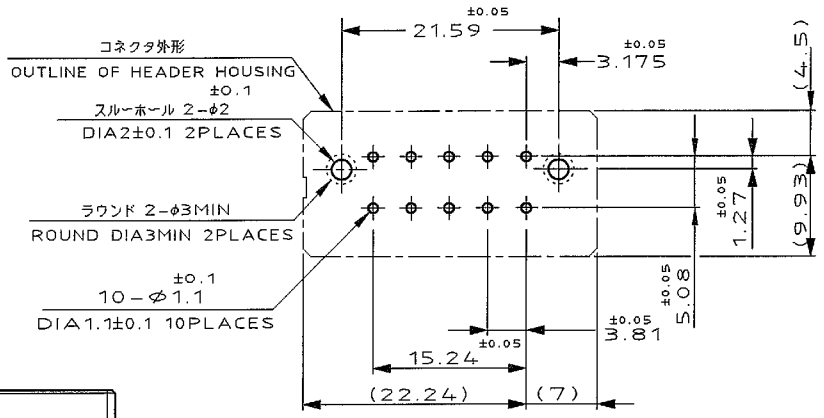
3rd ANGLE PROJECTION

METRIC

DIMENSIONS IN MILLIMETERS. DO NOT SCALE PRINT

PRINT DIST





推奨基板取付け穴寸法

PC 基板厚:1.6±0.1
(非累積公差)
(コネクタ搭載面)

RECOMEND PC BOARD HOLE PATTERN

PC BOARD THICKNESS:1.6±0.1
(NOT ACCUMULATE TOLERANCE)
(CONNECTOR MOUNT SIDE)

NOTES

1. MATERIAL:HOUSING:GLASS FILED THERMO PLASTIC,POLYESTER(94V-0),COLOR:BLACK
CONTACT:COPPER ALLOY
RETENTION LEG:COPPER ALLOY
2. FINISH(CONTACT AREA):0.38μmMIN GOLD PLATING OVER Ni PLATING
3. FINISH(CONTACT AREA):0.76μmMIN GOLD PLATING OVER Ni PLATING
4. FINISH(CONTACT AREA):2.0 μmMIN TIN PLATED OVER NICKEL
5. ~~FINISH(RETENTION LEG): TIN-LEAD PLATED (CONTACT TAIL) OVER NICKEL~~
6. FINISH(RETENTION LEG): TIN PLATED (CONTACT TAIL) OVER NICKEL

注記

1. 材料: ハウジング: ガラス入り熱可塑性
ポリエステル樹脂 (94V-0),色: 黒
コンタクト: 銅合金
リテンションレグ: 銅合金
2. めっき: コンタクト: 全面Ni下地
接触部: 0.38μm MIN金めっき
3. めっき: コンタクト: 全面Ni下地
接触部: 0.76μm MIN金めっき
4. めっき: コンタクト: 全面Ni下地
接触部: 2.0 μm MINスズめっき
5. ~~めっき: リテンションレグとコンタクト半田付部 ニッケル下地の上に半田めっき~~
6. めっき リテンションレグとコンタクト半田付部: ニッケル下地の上にスズめっき

6 4	178325-5
6 3	178325-3
6 2	178325-2
(FINISH)	製品番号 (PART NO.)

LTR	REVISION RECORD		DR	CHK	DATE
E	REVISED	FJDO-0039-03	TS	S.M	6/2 '03
D	REVISED	FJDO-0097-03	TS	S.M	4/15 '03
C	REVISED	FJ00-2744-95	KI	Y.I	6/16 '95
B	REVISED	FJ00-0838-94	NM	S.M	7/4 '94
A	REDRAWN WITH CHANGE	FJ00-0480-94	NM	S.M	4/20 '94

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tyco Electronics

Tyco Electronics AMP K.K
Kawasaki,Japan

WIRE RANGE	INSULATION DIA
mm²(AWG -)	- mmφ
MATERIAL	SEE NOTE 注記参照
FINISH	SEE NOTE 注記参照
DR. 19 APR 94	N.Matsubara
DE. 19 APR 94	N.Matsubara
CHK. 20 APR 94	S.MANABE
APP. 20 APR 94	S.MANABE

NAME
10 POS DOUBLE ROW
VERTICAL HDR ASS'Y FOR DYNAMIC D-3100

一般公差 (GENERAL TOLERANCE)	
10未満	±0.3
10以上30未満	±0.4
30以上100未満	±0.45
角度	±3°

SIZE	LOC	NUMBER
A3	J	C-178325

SCALE	REV.	SHEET
2-1	E	1 OF 1

AMP-J
REV.10/'83

(CUSTOMER DRAWING) 顧客用図面